

SIS698DN-T1-GE3-VB Datasheet N-Channel 100-V (D-S) MOSFET

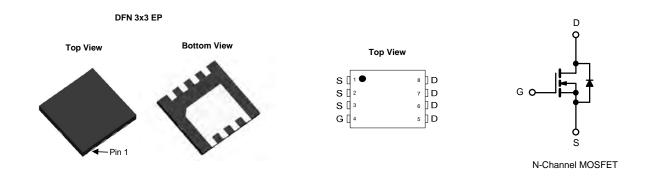
PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)		
100	0.010 at V _{GS} = 10 V	50		

FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

APPLICATIONS

• Isolated DC/DC Converters



Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current ($T_1 = 175 \text{ °C}$)	T _C = 25 °C	L	50		
Continuous Drain Current (1) = 175 C)	T _C = 125 °C	I _D	45		
Pulsed Drain Current	I _{DM}	60	A		
Avalanche Current	L = 0.1 mH	I _{AS}	51		
Single Pulse Avalanche Energy ^b	L = 0.1 min	E _{AS}	60	mJ	
Maria Brance Diaria atia b	T _C = 25 °C	P	355 ^c	10/	
Maximum Power Dissipation ^b	T _A = 25 °C ^d	P _D	3.35	W	
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV		

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25^{\circ}$	C, unless o	therwise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А	
		V _{GS} = 10 V, I _D = 30 A		0.010		Ω	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.013			
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.027			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}			3200		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		410			
Reverse Transfer Capacitance	C _{rss}			210			
Total Gate Charge ^c	Qg			90	130		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 58 A		23		nC	
Gate-Drain Charge ^c	Q _{gd}			34			
Gate Resistance	R _g		0.5	1.3	3.1	Ω	
Turn-On Delay Time ^c	t _{d(on)}			24	35	ns	
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 1.5 Ω		220	330		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 58$ A, $V_{GEN} = 10$ V, $R_g = 2.5$		45	70		
Fall Time ^c	t _f	Ω		200	300		
Source-Drain Diode Ratings and Ch	aracteristics 7	_C = 25 °C ^b	•				
Continuous Current	ا _S				58	A	
Pulsed Current	I _{SM}			1	110		
Forward Voltage ^a	V _{SD}	$I_{F} = 58 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 30 A, di/dt = 100 A/µs		8	12	А	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

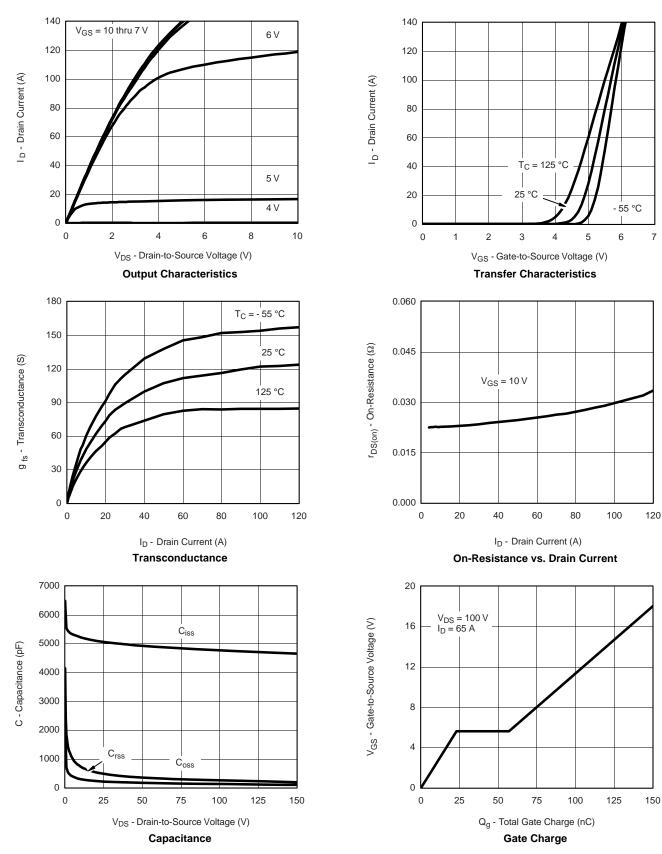
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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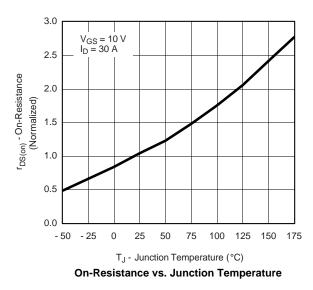
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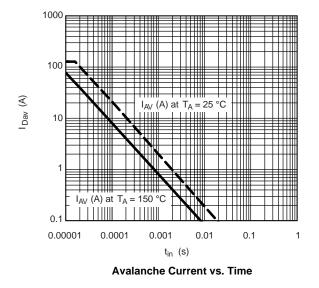
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

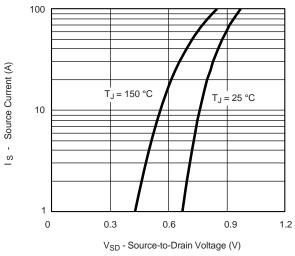




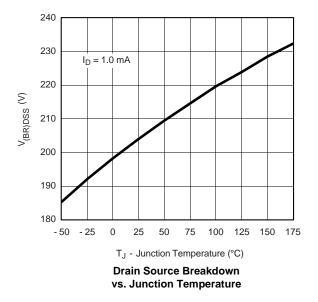
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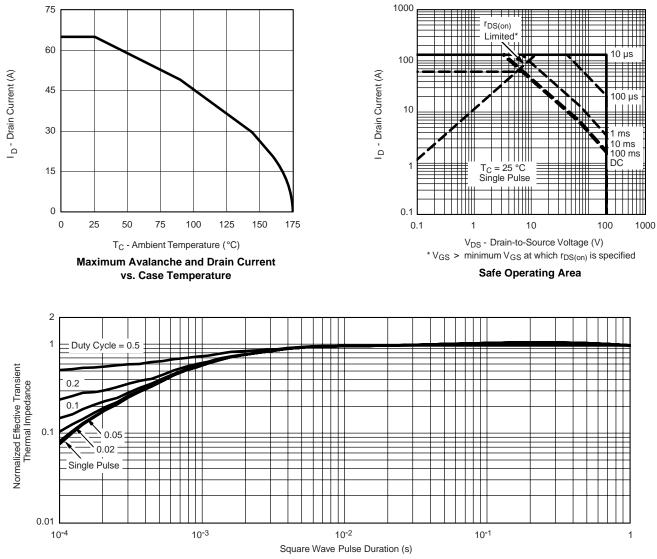
Source-Drain Diode Forward Voltage



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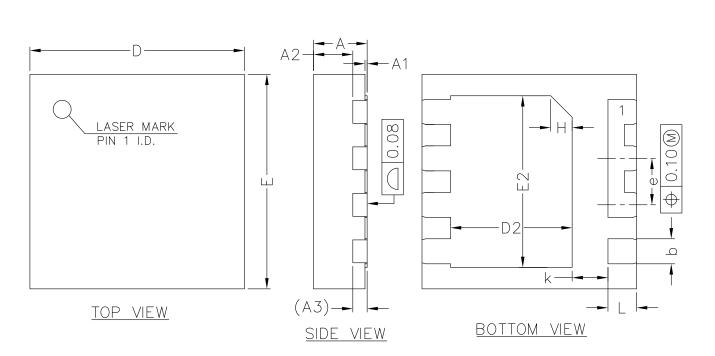


THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case

SIS698DN-T1-GE3-VB





<u>SIDE VIEW</u>

(UNITS OF MEASURE=MILLIMETER)					
SYMBOL	MIN	NOM	MAX		
А	0.70	0.75	0.80		
A1	0.00	0.02	0.05		
Α2	0.50	0.55	0.60		
АЗ	0.20REF				
b	0.30	0.35	0.40		
D	2.90	3.00	3.10		
E	2.90	3.00	3.10		
D2	1.60	1.70	1.80		
E2	2.30	2.40	2.50		
e	0.55	0.65	0.75		
К	0.40	0.50	0.60		
L	0.35	0.40	0.45		

COMMON DIMENSIONS

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